

Surge arrester

B88069X1640T902

2-electrode arrester

M50-C90XSMD


Features

- Very small size
- High current rating
- Very fast response time
- Stable performance over life
- Very low capacitance
- High insulation resistance
- Excellent SMD handling
- RoHS-compatible

Applications

- Modem
- XDSL-splitter
- Data lines
- Tuner
- Antenna

Electrical specifications

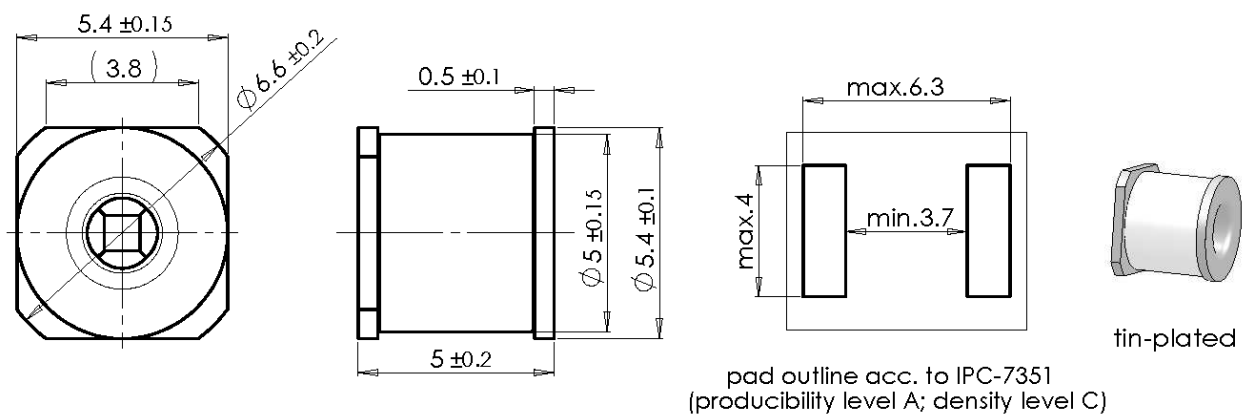
DC spark-over voltage ^{1) 2)}	90	V
Tolerance	±20	%
Min.	72	V
Max.	108	V
Impulse spark-over voltage		
at 100 V/μs - for 99% of measured values	< 550	V
- typical values of distribution	< 500	V
at 1 kV/μs - for 99% of measured values	< 600	V
- typical values of distribution	< 550	V
Service life		
10 operations 50 Hz, 1 s	5	A
1 operations 50 Hz, 0.18 s (9 cycles)	10	A
10 operations 8/20 μs	5	kA
1 operation 8/20 μs	10	kA
1 operation 10/350 μs	0.5	kA
300 operations 10/1000 μs	100	A
Insulation resistance at 50 V _{DC}	> 1	GΩ
Capacitance at 1 MHz	< 1	pF
Arc voltage at 1 A	~ 10	V
Glow to arc transition current	< 0.7	A
Glow voltage	~ 55	V
Weight	~ 1	g
Operation and storage temperature	-40 ... +125	°C
Climatic category (IEC 60068-1)	40/125/21	
Marking, blue negative	EPCOS 90 YY O 90 - Nominal voltage YY - Year of production O - Non radioactive	
Certification	UL 497B (E163070)	

¹⁾ At delivery AQL 0.65 level II, DIN ISO 2859

²⁾ In ionized mode

Terms in accordance with ITU-T Rec. K.12; IEC 61663-2 and IEC 61643-311.

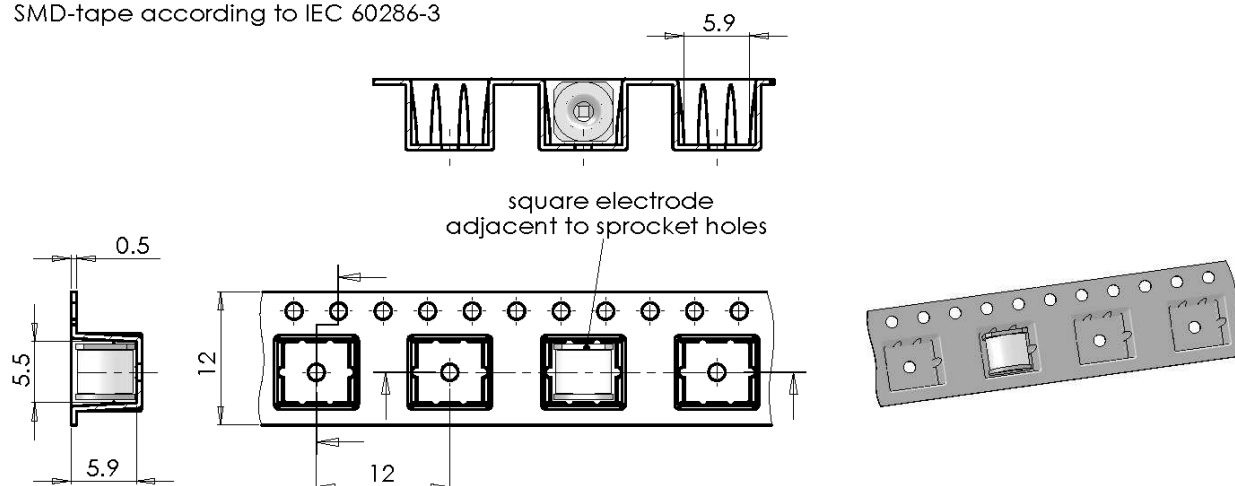
Dimensional drawing in mm



Ordering code and packing advice

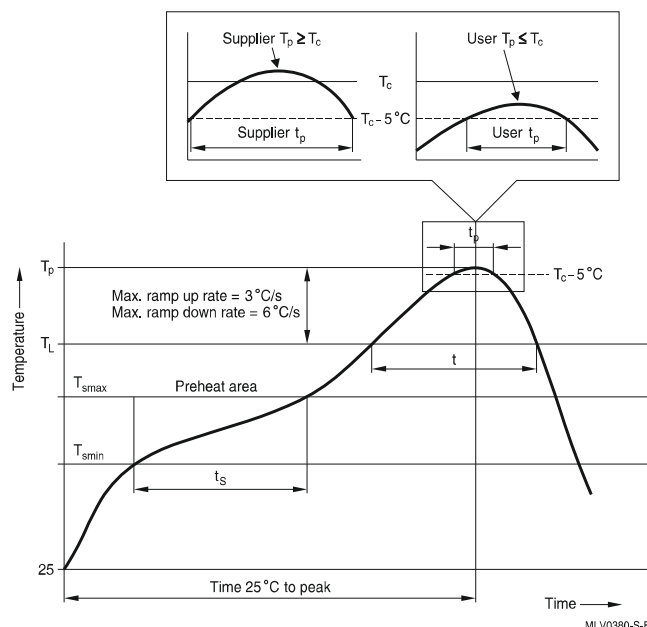
B88069X1640T902 = 900 pcs. on SMD-tape

SMD-tape according to IEC 60286-3



Soldering parameter

Reflow soldering



Reflow profile features		Sn- Pb eutectic assembly	Pb-free assembly
Preheat and soak - Temperature min - Temperature max - Time	T_{smin} T_{smax} t_{smin} to t_{smax}	100 °C 150 °C 60 ... 120 s	150 °C 200 °C 60 ... 180 s
Average ramp-up rate	T_{smax} to T_p	max. 3 °C/ s	max. 3 °C/ s
Liquidous temperature Time at liquidous	T_L t_L	183 °C 60 ... 150 s	217 °C 60 ... 150 s
Peak package body temperature *, Classification temperature **	T_p , T_C	220 ... 235 °C **	245 ... 260 °C **
Time (t_p) ** within 5 °C of the specified classification temperature (T_C)		20 s ***	30 s ***
Average ramp-down rate	T_p to T_{smax}	max. 6 °C/ s	max. 6 °C/ s
Time 25 °C to peak temperature		max. 6 min	max. 8 min

* = Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.
 ** = For details please refer to JEDEC J-STD-020D.
 *** = Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

Surface mounted components (SMD) may exhibit a temporary increase in the DC spark-over voltage after the solder reflow process. The components will recover within 24 hours. There is no quality defect nor change in protection levels during the temporary change in DC spark-over voltage.

Cautions and warnings

- Do not operate surge arresters in power supply networks, whose maximum operating voltage exceeds the minimum spark-over voltage of the surge arresters.
- Surge arresters may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
- If the contacts of the surge arresters are defective, current load can cause sparks and loud noises.
- Surge arresters must be handled with care and must not be dropped.
- Do not continue to use damaged surge arresters.

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